# VT6T1 / EMT51

# Power management (dual transistors)

Datasheet

Parameter	Tr1 and Tr2
V <sub>CEO</sub>	-20V
I <sub>C</sub>	-200mA

# ●Outline

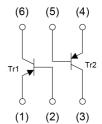


### Features

- 1) General Purpose.
- 2) Two 2SAR522 chips in one package.
- 3) Transister elements are independent, eliminating interface.
- 4) Mounting cost and area can be cut in half.

### •Inner circuit

- (1) Tr1 Emitter
- (2) Tr1 Base
- (3) Tr2 Collector
- (4) Tr2 Emitter
- (5) Tr2 Base
- (6) Tr1 Collector



### Application

SWITCH, LED DRIVER

### Packaging specifications

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Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
VT6T1	(VMT6)	1212	T2R	180	8	8000	T1
EMT51	SOT-563 (EMT6)	1616	T2R	180	8	8000	T51

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<It is the same ratings for the Tr1 and Tr2>

Parameter			Symbol	Values	Unit
Collector-base voltage			V <sub>CBO</sub>	-20	V
Collector-emitter voltage			V <sub>CEO</sub>	-20	V
Emitter-base voltage			V <sub>EBO</sub>	-5	V
			I <sub>C</sub>	-200	mA
Collector current		I <sub>CP</sub> *1	-400	mA	
Power dissipation VT6T1		D *2*3	150	mW	
EMT51			P <sub>D</sub> *2*3		150
Junction temperature			Tj	150	°C
Range of storage temperature			T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

<It is the same characteristics for the Tr1 and Tr2>

Davameter	Cumbal	Conditions	Values			I India	
Parameter	Symbol	Conditions		Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -50μA	-20	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-20	-	-	V	
Emitter-base breakdown voltage	$BV_{EBO}$	I <sub>E</sub> = -50μA	-5	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -20V	-	1	-100	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -5V	-	-	-100	nA	
Collector-emitter saturation voltage V <sub>CE(s</sub>		I <sub>C</sub> = -100mA, I <sub>B</sub> = -10mA	-	-120	-300	mV	
DC current gain	h <sub>FE</sub>	$V_{CE} = -2V$ , $I_C = -1mA$	120	-	560	-	
Transition frequency	f <sub>⊤</sub>	V <sub>CE</sub> = -10V, I <sub>E</sub> = 10mA, f = 100MHz	-	350	-	MHz	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A, f = 1MHz	-	3.0	-	pF	

<sup>\*1</sup> Pw=1ms Single Pulse



<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3 120</sup>mW per element must not be exceeded.

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.1 Ground Emitter Propagation

Characteristics

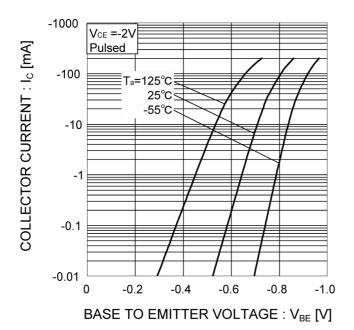
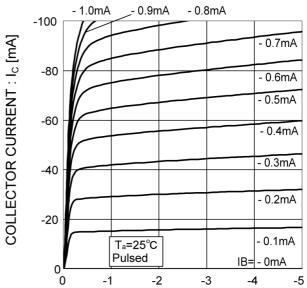


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current (I)

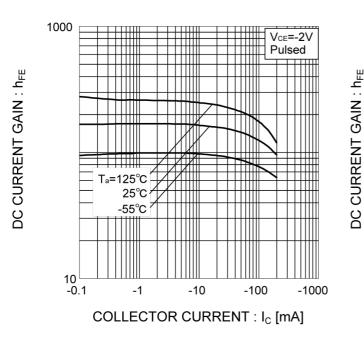
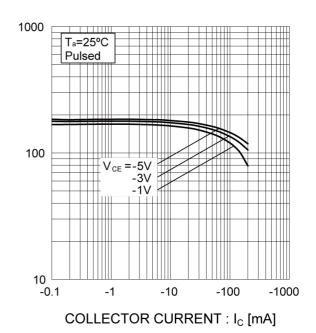


Fig.4 DC Current Gain vs. Collector
Current (II)



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## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

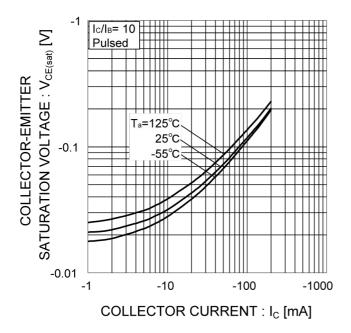
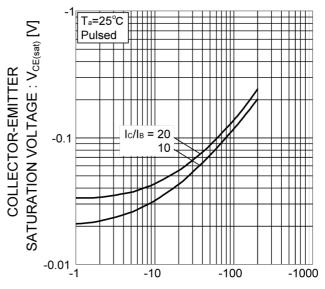


Fig.6 Collector-Emitter Saturation

Voltage vs. Collector Current (II)



COLLECTOR CURRENT : I<sub>C</sub> [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

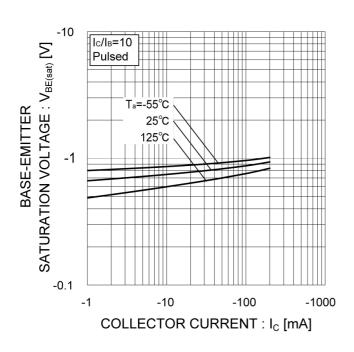
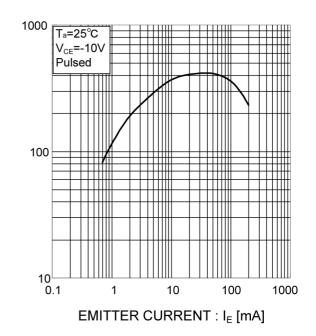


Fig.8 Gain Bandwidth Product vs.

Emitter Current



TRANSITION FREQUENCY : fr [MHz]

# ● Electrical characteristic curves (T<sub>a</sub> =25°C)

<For Tr1 and Tr2 in common>

Fig.9 Emitter Input Capacitance vs.

Emitter-Base Voltage

Collector Output Capacitance vs.

Collector-Base Voltage

COLLECTOR OUTPUT CAPACITANCE: Cob [PF]

Ta=55°C

Ta=0A

IC=0A

O'T

O'T

Ta=0A

IC=0A

O'T

Ta=0A

IC=0A

O'T

Ta=0A

IC=0A

Ta=0A

IC=0A

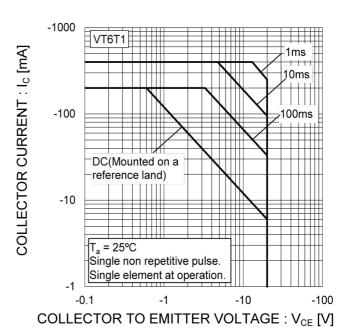
Ta=0A

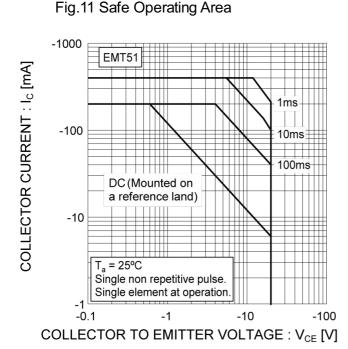
Ta=

COLLECTOR-BASE VOLTAGE: V<sub>CB</sub> [V]

EMITTER-BASE VOLTAGE: VCB [V]

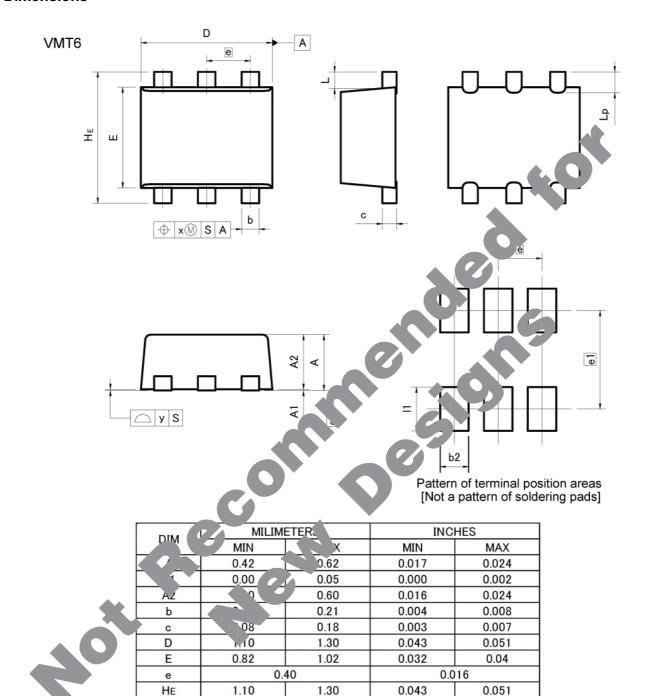
Fig.10 Safe Operating Area





ROHM SEMICONDUCTOR

### Dimensions



У		0.10	-	0.004				
DIM	MILIMETERS		INCHES					
DIM	MIN	MAX	MIN	MAX				
b2	_	0.26	1	0.010				
e1	0.90		0.0	35				
11		0.40	_	0.016				

0.30

0.05

0.14

0.10

Dimension in mm/inches

L

Lр



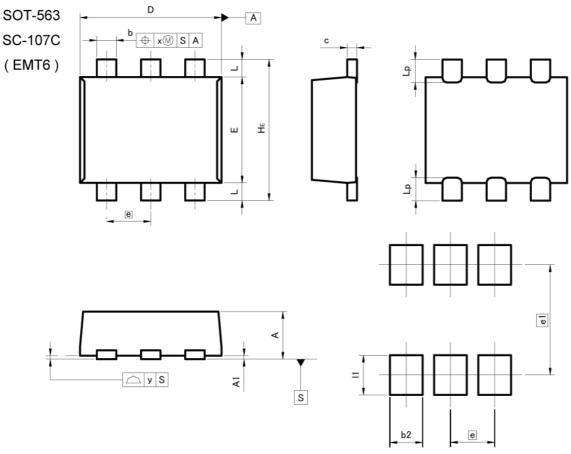
0.006

0.012

0.002

0.004

### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
С	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.9	50	0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	_	0.35	-	0.014	
х	_	0.10	_	0.004	
У	_	0.10	-	0.004	

DIM	MILIM	ETERS	INCHES		
DIW	MIN	MAX	MIN	MAX	
b2	- 0.37		- 0.015		
e1	1.25		0.0	49	
11	- 0.45		1	0.018	

Dimension in mm/inches



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1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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